| ASSOCIATION CONNECT                            | Material Composities<br>© Copyright 2005. IPC, H<br>international and Pan-Am | Bannockb  | urn, Illinois. A  | ll rights reserved utions. | under both    | This docume<br>level parts, t | ent is a decl<br>he declarati                                   | aration<br>ion enc                | n of the sub<br>compasses a | ostances v<br>all lower | vithin the<br>level mat         | manufactur<br>erials for w      | er listed it hich the m | em. No<br>anufac                 | ote: if the | e item is an as<br>s engineering | sembly with lower<br>esponsibility. |
|--|--|---|---|----------------------------|---------------|-------------------------------|---|-----------------------------------|-----------------------------|-------------------------|---------------------------------|---------------------------------|-------------------------|----------------------------------|-------------|----------------------------------|-------------------------------------|
| 1752-21.1                                      |  | IPC Web Site for Information on IPC-1752 Standard Form Type<br>http://www.ipc.org/IPC-175x Distribute |   |                            |               | *                             | Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Mater |                                   |                             |                         |                                 | als and Mfg Information         |                         |                                  |             |                                  |                                     |
| Supplier Inform                                | mation   |   |   |                            |               |                               |   |                                   |                             |                         |                                 |                                 |                         |                                  |             |                                  |                                     |
| Company name*                                  | Company unique ID  |   |   | Unique ID Authority        |               |                               |   |                                   | Response Date*              |                         |                                 |                                 |                         |                                  |             |                                  |                                     |
| onsemi   |  |   |   |                            |               |                               |   |                                   |                             |                         | 2024-05-12                      |                                 |                         |                                  |             |                                  |                                     |
| Contact Name                                   |  | Title - Contact   |   |                            |               | Phone - Contact*              |   |                                   |                             |                         | Email - Contact*                |                                 |                         |                                  |             |                                  |                                     |
| Product-Env-Stew                               | vards  | Product Enviro Compliance   |   |                            |               | NA                            |   |                                   |                             |                         | Product-Env-Stewards@onsemi.com |                                 |                         |                                  |             |                                  |                                     |
| Authorized Representative*                     |  |   | Title - Representative  |                            |               |                               | Phone - Representative*   |                                   |                             |                         |                                 | Email - Representative*         |                         |                                  |             |                                  |                                     |
| Product-Env-Stewards                           |  |   | Product Enviro Compliance   |                            |               |                               | NA  |                                   |                             |                         |                                 | Product-Env-Stewards@onsemi.com |                         |                                  |             |                                  |                                     |
| Reques   | Requester Item Number Mfr Item   |   | n Number Mfr Item Name  |                            |               |                               | Effective I   | e Date Version Manufacturing Site |                             | ing Site                | V                               | Veight                          | *                       | UOM                              | Unit Type   |                                  |                                     |
|  | NCP110.  |   | AMX280TBG 200 mA, Low VIN, Low Noise and High<br>PSRR LDO, AD 2V8 |                            |               | nd High                       | 2024-05-1   | 2                                 |                             | Т                       | ТНВ                             |                                 |                         | .434                             |             | mg                               | Each                                |
| Manufacturing                                  | g Proccess Information   |   |   |                            |               |                               |   |                                   |                             |                         |                                 |                                 |                         |                                  |             |                                  |                                     |
| Termina  | Terminal Plating / Grid Array Material                                       |   | erminal Base Alloy J-STI  |                            | J-STD-020 MSL | MSL Rating                    |   | Peak Process Body Temperatur      |                             | nperatur                | are Max Time at Peak Tempe      |                                 | Temperat                | perature Number of Reflow Cycles |             | les                              |                                     |
| Precious metal (e.g. Ag,Au, NiPdAu) (no<br>Sn) |  |   | CU Alloy 1  |                            | 1             |                               | 260   |                                   | С                           |                         | 30                              |                                 | seconds 3               |                                  | •           |                                  |                                     |
| Comments                                       |  |   |   |                            |               |                               |   |                                   |                             |                         |                                 |                                 |                         |                                  |             |                                  |                                     |
| evel 1 - maximum                               | time at peak temperature d   | uring sol   | dering is 10-3  | 0 seconds                  |               |                               |   |                                   |                             |                         |                                 |                                 |                         |                                  |             |                                  |                                     |
| for more informat                              | tion regarding material com  | position <sub>l</sub>   | please refer to   | page 3                     |               |                               |   |                                   |                             |                         |                                 |                                 |                         |                                  |             |                                  |                                     |

| RoHS Material Composition Declaration  |  |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |  |  |
|--|--|--|---|---|---|--|--|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | ending RoHS RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP). |  |   |   |   |  |  |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>v others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the   | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa  | ances per the definitio  | on above  | Supplier Acceptance                             | * Accepted  |  |  |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per   | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU   |  |   |   |   |  |  |  |  |  |  |  |  |
| Declaration Signature  |  |  |   |   |   |  |  |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester  | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska  | Le   |   |   |   |  |  |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight | Unit of Measure | Level    | Substance  | CAS         | Exempt   | Weight | Unit of Measure |
|----------------------|--------|-----------------|----------|--|-------------|----------|--------|-----------------|
| Die                  | 0.09   | mg              | Supplier | Silicon (Si)   | 7440-21-3   | <b>r</b> | 0.09   |                 |
| Die Attach           | 0.13   | mg              | Supplier | Epoxized Condensate Of Para-<br>Hydrobenzaldehyde And Alkyl Phenol | 129915-35-1 |          | 0.0416 | mg              |
|                      |        |                 | Supplier | Aluminum Trioxide (Al2O3)  | 1344-28-1   |          | 0.0884 | mg              |
| Lead Frame           | 0.58   | mg              | Supplier | Tin (Sn)   | 7440-31-5   |          | 0.0014 | mg              |
|                      |        |                 | Supplier | Zinc (Zn)  | 7440-66-6   |          | 0.0013 | mg              |
|                      |        |                 | Supplier | Chromium (Cr)  | 7440-47-3   |          | 0.0014 | mg              |
|                      |        |                 | Supplier | Copper (Cu)  | 7440-50-8   |          | 0.5758 | mg              |
| Mold Compound-Black  | 0.6    | mg              | Supplier | Epoxy and Phenolic Resin   | 40216-08-8  |          | 0.048  | mg              |
|                      |        | -               | Supplier | Carbon Black (C)   | 1333-86-4   |          | 0.003  | mg              |
|                      |        |                 | Supplier | Aluminum Hydroxide (Al(OH)3)                                       | 21645-51-2  |          | 0.012  | mg              |
|                      |        |                 | Supplier | Fused Silica (SiO2)  | 60676-86-0  |          | 0.519  | mg              |
|                      |        |                 | Supplier | Phenolic Resin (Novolac)   | 9003-35-4   |          | 0.018  | mg              |
| Plating              | 0.004  | mg              | Supplier | Palladium (Pd)   | 7440-05-3   |          | 0.0001 | mg              |
|                      |        |                 | В        | Nickel (Ni)  | 7440-02-0   |          | 0.0035 | mg              |
|                      |        |                 | Supplier | Gold (Au)  | 7440-57-5   |          | 0.0004 | mg              |
| Wire Bond - Au       | 0.03   | mg              | Supplier | Gold (Au)  | 7440-57-5   |          | 0.03   | mg              |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).